

zQSFP+/QSFP28

TE Internal #: 2299940-4

zQSFP+/QSFP28, QSFP/QSFP+/zQSFP+, Cage Assembly with Integrated Connector, Port Matrix Configuration 2 x 1, Internal

/External EMI Springs

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Connectors > Pluggable IO Connectors & Cages > QSFP/QSFP+/zQSFP+











Pluggable I/O Product Type: Cage Assembly with Integrated Connector

Port Matrix Configuration: 2 x 1

EMI Containment Feature Type: Internal/External EMI Springs

Thermal Accessory Type Included: Heat Sink

Included Lightpipe: No

Features

Product Type Features

| Form Factor | zQSFP+ |
|-------------------------------------|---|
| Cage Type | Stacked |
| Pluggable I/O Product Type | Cage Assembly with Integrated Connector |
| Thermal Accessory Type Included | Heat Sink |
| Connector System | Cable-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| Configuration Features | |
| Port Matrix Configuration | 2 x 1 |
| Number of Ports | 2 |
| Number of Rear EONs per Port Column | 3 |
| Number of Positions | 76 |

25 Gb/s

Electrical Characteristics

Data Rate (Max)



Body Features

| body reatures | |
|---|---|
| Heat Sink Finish | Anodized Black |
| Heat Sink Style | Fin |
| Contact Features | |
| Contact Mating Area Plating Material | Gold |
| Contact Mating Area Plating Thickness | 30 μm[.76 μin] |
| Contact Underplating Material | Tin |
| PCB Contact Termination Area Plating Material | Gold |
| Contact Current Rating (Max) | .5 A |
| Termination Features | |
| Termination Method to Printed Circuit Board | Through Hole - Press-Fit |
| Mechanical Attachment | |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Cage Material | Nickel Silver |
| Centerline (Pitch) | .8 mm[.032 in] |
| Dimensions | |
| PCB Thickness (Recommended) | 1.58 mm[.063 in] |
| Tail Length | 2 mm[.079 in] |
| Usage Conditions | |
| Operating Temperature Range | -40 - 85 °C[-40 - 185 °F][-40 - 185 °F] |
| Operation/Application | |
| Heat Sink Compatible | No |
| For Use With Pluggable I/O Products | QSFP28 Cable Assembly, QSFP28 MSA Compatible Transceiver |
| Pluggable I/O Applications | Thermally Enhanced |
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Method | Box & Tray |
| | |



Other

| EMI Containment Feature Type | Internal/External EMI Springs |
|------------------------------|-------------------------------|
| Included Lightpipe | No |
| Enhancements | Thermally Enhanced |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Not applicable for solder process capability |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



TE Part # 2821309-4 QSFP TO [2]QSFP, 28G, 3 METER, 30AWG



TE Part # 2821309-7 QSFP TO [2]QSFP, 28G, 1 METER, 33AWG



TE Part # 2821309-8 QSFP TO [2]QSFP, 28G, 3 METER, 28AWG



TE Part # 2821309-3 QSFP TO [2]QSFP, 28G, 3 METER, 26AWG





TE Part # 2821309-5 QSFP TO [2]QSFP, 28G, 2 METER, 26AWG



TE Part # 2821309-9 QSFP TO [2]QSFP, 28G, 5 METER, 26AWG



TE Part # 2821309-2 QSFP TO [2]QSFP, 28G, 2 METER, 30AWG



TE Part # 2829040-2 QSFP IB EDR, 33AWG, 1.0M



TE Part # 2829040-4 QSFP IB EDR, 30AWG, 1.0M



TE Part # 2829040-6 OSFP IB EDR, 30AWG, 2.0M



TE Part # 2829040-7 QSFP IB EDR, 26AWG, 2.0M



TE Part # 2829040-8 QSFP IB EDR, 26AWG, 3.0M



TE Part # 2821033-8 QSFP TO [4]SFP+, 28G, 1M, 33AWG





Pluggable I/O Cable Assemblies(84)



QSFP/QSFP+/zQSFP+(430)

Customers Also Bought



















Documents

Product Drawings

ZQSFP+ STACKED REC ASSEMBLY 2X1,HS

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2299940-4_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2299940-4_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2299940-4_A.3d_stp.zip

English

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Product Specifications

Application Specification

English

Product Environmental Compliance

MD_2299940-4_06272017045_dmtec

English

MD_2299940-4_06272017045_dmtec

English